



PROTON – ELECTROTEX RUSSIA

Pressure contact
Low switching losses
Low reverse recovery charge
High power cycling capability
Distributed amplified gate for high di_T/dt

Fast Inverter Stud Thyristor Type TFI271-250-14

Mean on-state current			I_{TAV}	250 A	
Repetitive peak off-state voltage			V_{DRM}	1000...1400 V	
Repetitive peak reverse voltage			V_{RRM}		
Turn-off time			t_q	25.0, 32.0, 40.0, 50.0 μs	
V_{DRM}, V_{RRM}, V	1000	1100	1200	1300	1400
Voltage code	10	11	12	13	14
$T_{ij}, ^\circ C$	-60...+125				

MAXIMUM ALLOWABLE RATINGS

Symbols and parameters		Units	Values	Test conditions	
ON-STATE					
I_{TAV}	Maximum allowable mean on-state current	A	250 266 399	$T_c=88\text{ }^{\circ}\text{C};$ $T_c=85\text{ }^{\circ}\text{C};$ $T_c=55\text{ }^{\circ}\text{C};$ 180° half-sine wave; 50 Hz	
I_{TRMS}	RMS on-state current	A	392	$T_c=88\text{ }^{\circ}\text{C};$ 180° half-sine wave; 50 Hz	
I_{TSM}	Surge on-state current	kA	7.0 8.1	$T_j=T_{j\text{ max}}$ $T_j=25\text{ }^{\circ}\text{C}$	180° half-sine wave; $t_p=10\text{ ms};$ single pulse; $V_D=V_R=0\text{ V};$ Gate pulse: $I_G=2\text{ A}; V_G=20\text{ V};$ $t_{GP}=50\text{ }\mu\text{S}; di_G/dt=1\text{ A}/\mu\text{S}$
			7.5 8.5	$T_j=T_{j\text{ max}}$ $T_j=25\text{ }^{\circ}\text{C}$	180° half-sine wave; $t_p=8.3\text{ ms};$ single pulse; $V_D=V_R=0\text{ V};$ Gate pulse: $I_G=2\text{ A}; V_G=20\text{ V};$ $t_{GP}=50\text{ }\mu\text{S}; di_G/dt=1\text{ A}/\mu\text{S}$
I^2t	Safety factor	$A^2s\cdot10^3$	240 320	$T_j=T_{j\text{ max}}$ $T_j=25\text{ }^{\circ}\text{C}$	180° half-sine wave; $t_p=10\text{ ms};$ single pulse; $V_D=V_R=0\text{ V};$ Gate pulse: $I_G=2\text{ A}; V_G=20\text{ V};$ $t_{GP}=50\text{ }\mu\text{S}; di_G/dt=1\text{ A}/\mu\text{S}$
			230 290	$T_j=T_{j\text{ max}}$ $T_j=25\text{ }^{\circ}\text{C}$	180° half-sine wave; $t_p=8.3\text{ ms};$ single pulse; $V_D=V_R=0\text{ V};$ Gate pulse: $I_G=2\text{ A}; V_G=20\text{ V};$ $t_{GP}=50\text{ }\mu\text{S}; di_G/dt=1\text{ A}/\mu\text{S}$
BLOCKING					
V_{DRM}, V_{RRM}	Repetitive peak off-state and Repetitive peak reverse voltages	V	1000...1400	$T_{j\text{ min}} < T_j < T_{j\text{ max}};$ 180° half-sine wave; 50 Hz; Gate open	
V_{DSM}, V_{RSM}	Non-repetitive peak off-state and Non-repetitive peak reverse voltages	V	1100...1500	$T_{j\text{ min}} < T_j < T_{j\text{ max}};$ 180° half-sine wave; single pulse; Gate open	
V_D, V_R	Direct off-state and Direct reverse voltages	V	$0.6\cdot V_{DRM}$ $0.6\cdot V_{RRM}$	$T_j=T_{j\text{ max}};$ Gate open	

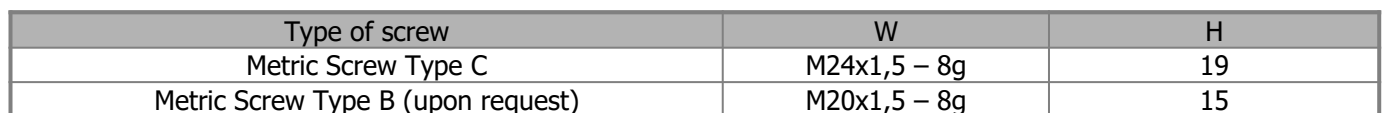
TRIGGERING				
I_{FGM}	Peak forward gate current	A	6	$T_j = T_{j\max}$
V_{RGM}	Peak reverse gate voltage	V	5	
P_G	Gate power dissipation	W	3	$T_j = T_{j\max}$ for DC gate current
SWITCHING				
$(di_T/dt)_{crit}$	Critical rate of rise of on-state current non-repetitive ($f=1$ Hz)	A/ μ s	1600	$T_j = T_{j\max}$; $V_D = 0.67 \cdot V_{DRM}$; $I_{TM} = 500$ A; Gate pulse: $I_G = 2$ A; $V_G = 20$ V; $t_{GP} = 50$ μ s; $di_G/dt = 2$ A/ μ s
THERMAL				
T_{stg}	Storage temperature	$^{\circ}$ C	-60...+50	
T_j	Operating junction temperature	$^{\circ}$ C	-60...+125	
MECHANICAL				
M	Tightening torque	Nm	25...35	
a	Acceleration	m/s ²	100	

CHARACTERISTICS

Symbols and parameters		Units	Values	Conditions	
ON-STATE					
V _{TM}	Peak on-state voltage, max	V	1.80	T _j =25 °C; I _{TM} =785 A	
V _{T(TO)}	On-state threshold voltage, max	V	1.168	T _j =T _{j max} ;	
r _T	On-state slope resistance, max	mΩ	0.915	0.5 π I _{TAV} < I _T < 1.5 π I _{TAV}	
I _L	Latching current, max	mA	1000	T _j =25 °C; V _D =12 V; Gate pulse: I _G =2 A; t _{GP} =50 μs; di _G /dt≥1 A/μs	
I _H	Holding current, max	mA	500	T _j =25 °C; V _D =12 V; Gate open	
BLOCKING					
I _{DRM} , I _{RRM}	Repetitive peak off-state and Repetitive peak reverse currents, max	mA	70	T _j =T _{j max} ; V _D =V _{DRM} ; V _R =V _{RRM}	
(dv _D /dt) _{crit}	Critical rate of rise of off-state voltage ¹⁾ , min	V/μs	200, 320, 500, 1000, 1600, 2000, 2500	T _j =T _{j max} ; V _D =0.67·V _{DRM} ; Gate open	
TRIGGERING					
V _{GT}	Gate trigger direct voltage, max	V	3.00 2.50 1.50	T _j = T _{j min} T _j =25 °C T _j = T _{j max}	V _D =12 V; I _D =3 A; Direct gate current
I _{GT}	Gate trigger direct current, max	mA	400 250 150	T _j = T _{j min} T _j = 25 °C T _j = T _{j max}	
V _{GD}	Gate non-trigger direct voltage, min	V	0.40	T _j =T _{j max} ;	
I _{GD}	Gate non-trigger direct current, min	mA	35.00	V _D =0.67·V _{DRM} ; Direct gate current	
SWITCHING					
t _{gd}	Delay time, max	μs	0.70	T _j =25 °C; V _D =600 V; I _{TM} =I _{TAV} ; di/dt=200 A/μs;	
t _{gt}	Turn-on time ²⁾ , max	μs	1.60, 2.00, 2.50, 3.20	Gate pulse: I _G =2 A; V _G =20 V; t _{GP} =50 μs; di _G /dt=2 A/μs	
t _q	Turn-off time ³⁾ , max	μs	25.0, 32.0, 40.0, 50.0	dv _D /dt=50 V/μs; T _j =T _{j max} ; I _{TM} = I _{TAV} ; di _R /dt=-10 A/μs; V _R =100V; V _D =0.67 V _{DRM}	
Q _{rr}	Recovered charge, max	μC	200	T _j =T _{j max} ; I _{TM} = I _{TAV} ;	
t _{rr}	Reverse recovery time, max	μs	4.0	di _R /dt=-50 A/μs;	
I _{rr}	Reverse recovery current, max	A	100	V _R =100 V	

THERMAL				
R_{thjc}	Thermal resistance, junction to case, max	$^{\circ}\text{C}/\text{W}$	0.085	Direct current
MECHANICAL				
m	Weight, max	g	450	
D_s	Surface creepage distance	mm (inch)	12.4 (4.882)	
D_a	Air strike distance	mm (inch)	12.4 (4.882)	

PART NUMBERING GUIDE								NOTES							
TFI	271	250	14	A2	E3	K4	N	1) Critical rate of rise of off-state voltage							
1	2	3	4	5	6	7	8	Symbol of Group (dv _D /dt) _{crit} , V/μs	P2 200	K2 320	E2 500	A2 1000	T1 1600	P1 2000	M1 2500
1. Fast Inverter Thyristor								2)Turn-on time							
2. Design version								Symbol of group	T4	P4	M4	K4			
3. Mean on-state current, A								t _{gr} , μs	1.60	2.00	2.50	3.20			
4. Voltage code								3)Turn-off time (dv _D /dt=50 V/μs)							
5. Critical rate of rise of off-state voltage								Symbol of group	M3	K3	H3	E3			
6. Group of turn-off time (dv _D /dt=50 V/μs)								t _{qr} , μs	25.0	32.0	40.0	50.0			
7. Group of turn-on time															
8. Ambient conditions; N – normal; T – tropica															

Package type: T.SB1

All dimensions in millimeters (inches)

page 4 of 12

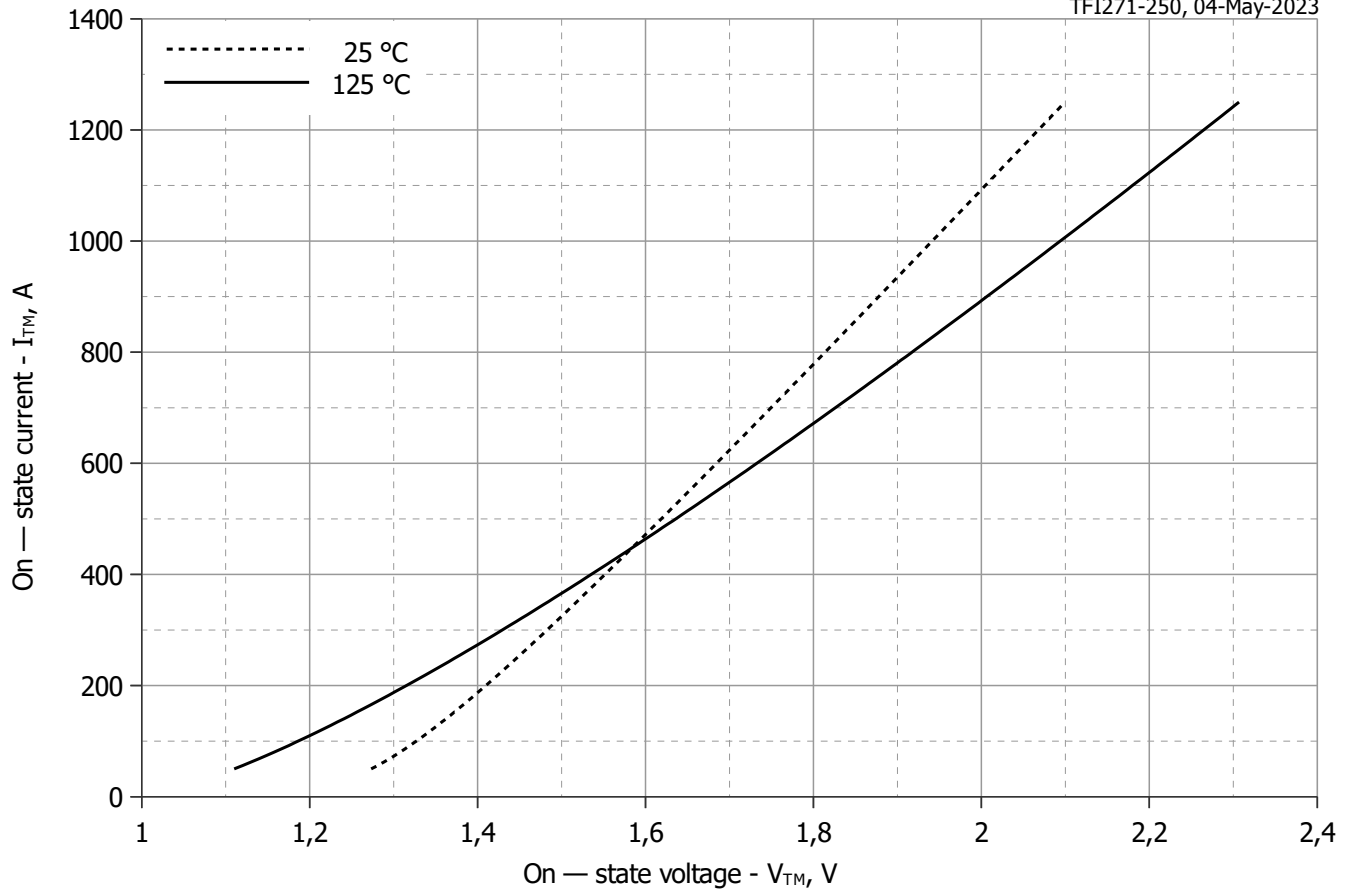


Fig 1 – On-state characteristics of Limit device

Analytical function for On-state characteristic:

$$V_T = A + B \cdot i_T + C \cdot \ln(i_T + 1) + D \cdot \sqrt{i_T}$$

	Coefficients for max curves	
	$T_j = 25^\circ\text{C}$	$T_j = T_{j\text{max}}$
A	1.09263934	1.00594146
B	0.00062523	0.00056105
C	0.04161039	-0.01747611
D	-0.00202149	0.02048342

On-state characteristic model (see Fig. 1)

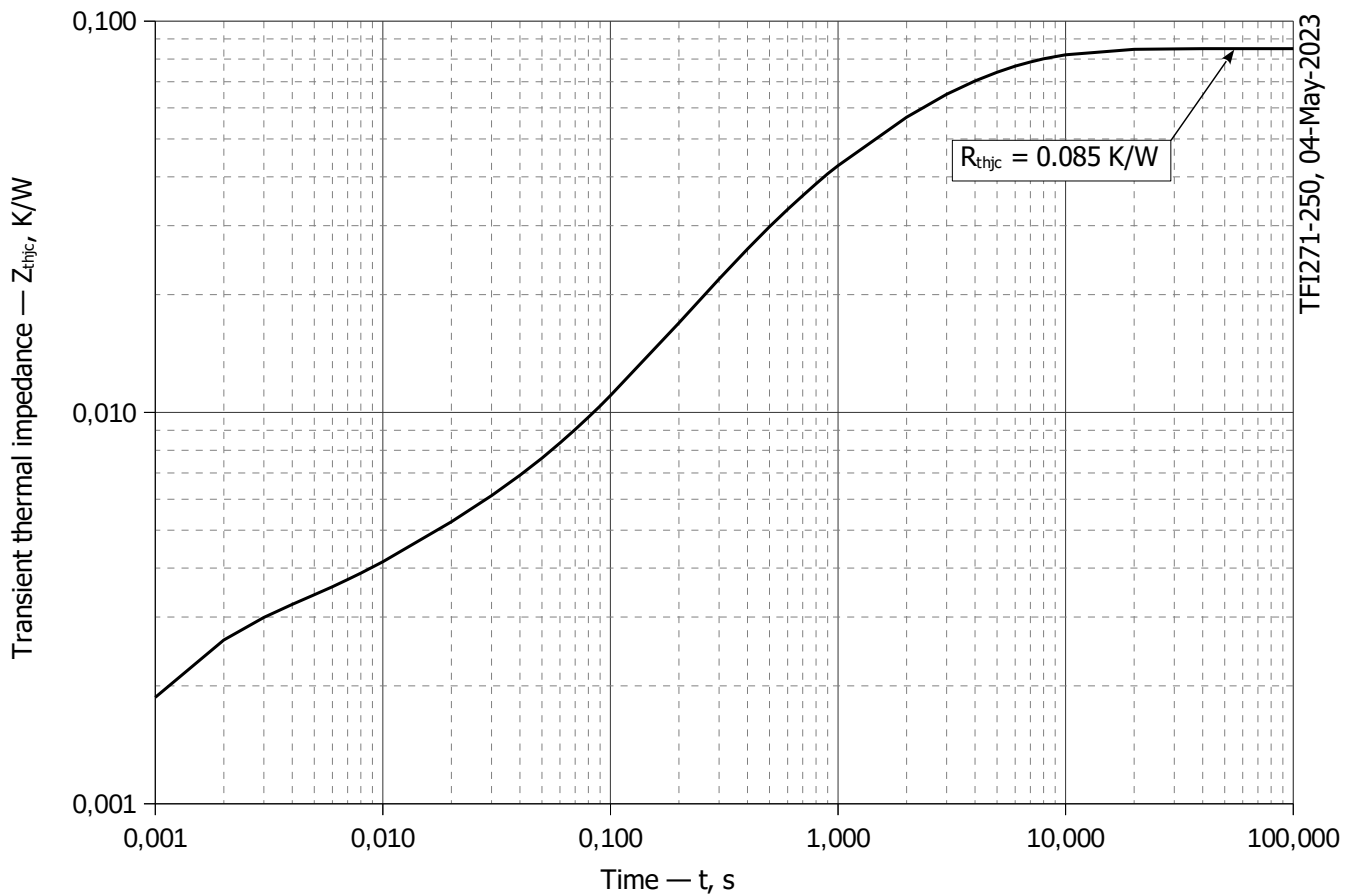


Fig 2 – Transient thermal impedance Z_{thjc} vs. time t

Analytical function for Transient thermal impedance junction to case Z_{thjc} for DC:

$$Z_{thjc} = \sum_{i=1}^n R_i \left(1 - e^{-\frac{t}{\tau_i}} \right)$$

Where $i = 1$ to n , n is the number of terms in the series.

t = Duration of heating pulse in seconds.

Z_{thjc} = Thermal resistance at time t .

R_i = Amplitude of p_{th} term.

τ_i = Time constant of r_{th} term.

DC

i	1	2	3	4	5	6
R_i , K/W	0.023357	0.02733	0.01495	0.001445	0.002488	0.01543
τ_i , s	4.627	2.249	0.3406	0.01043	0.0009112	0.9081

Transient thermal impedance junction to case Z_{thjc} model (see Fig. 2)

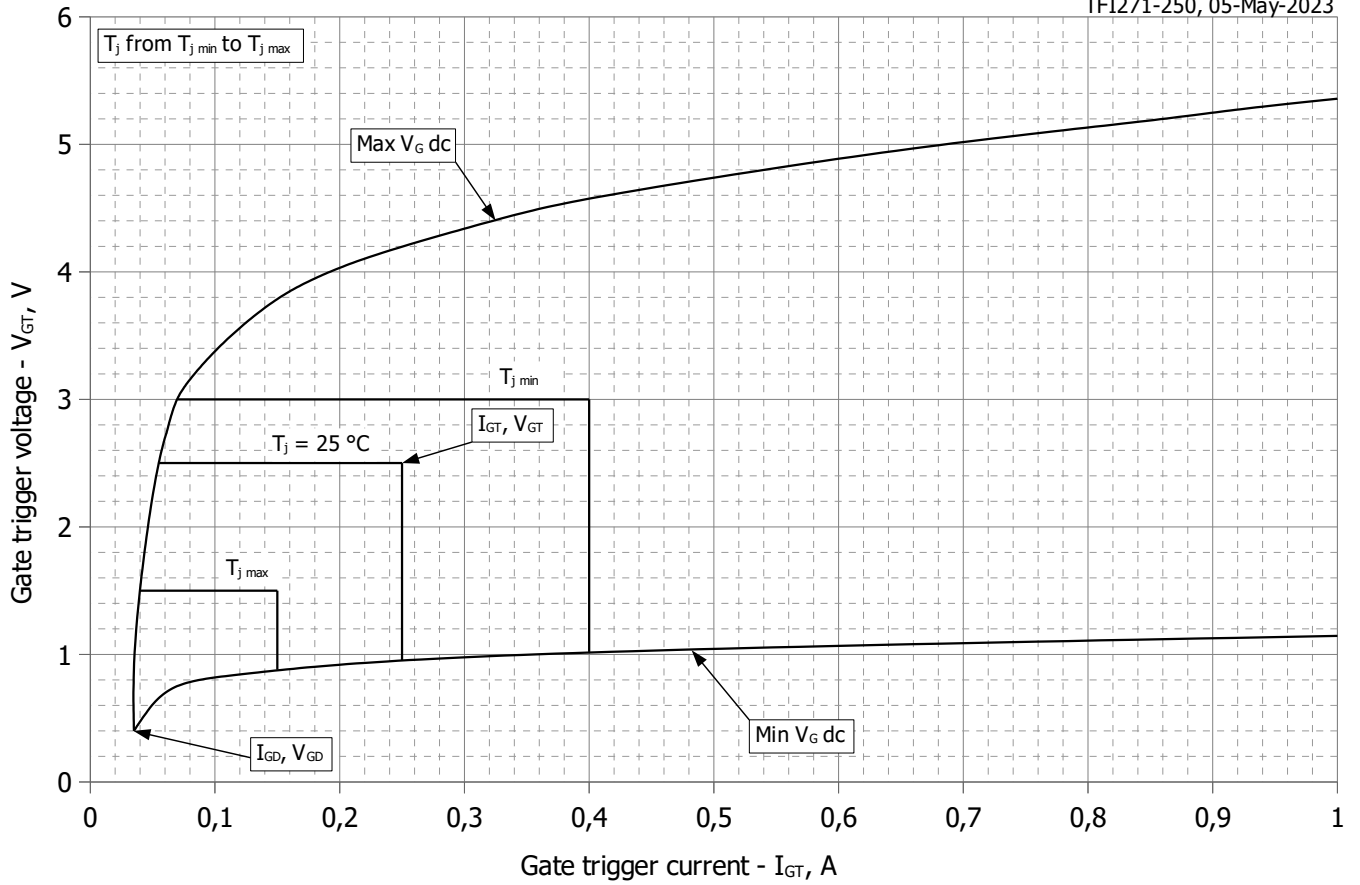


Fig 3 – Gate characteristics – Trigger limits

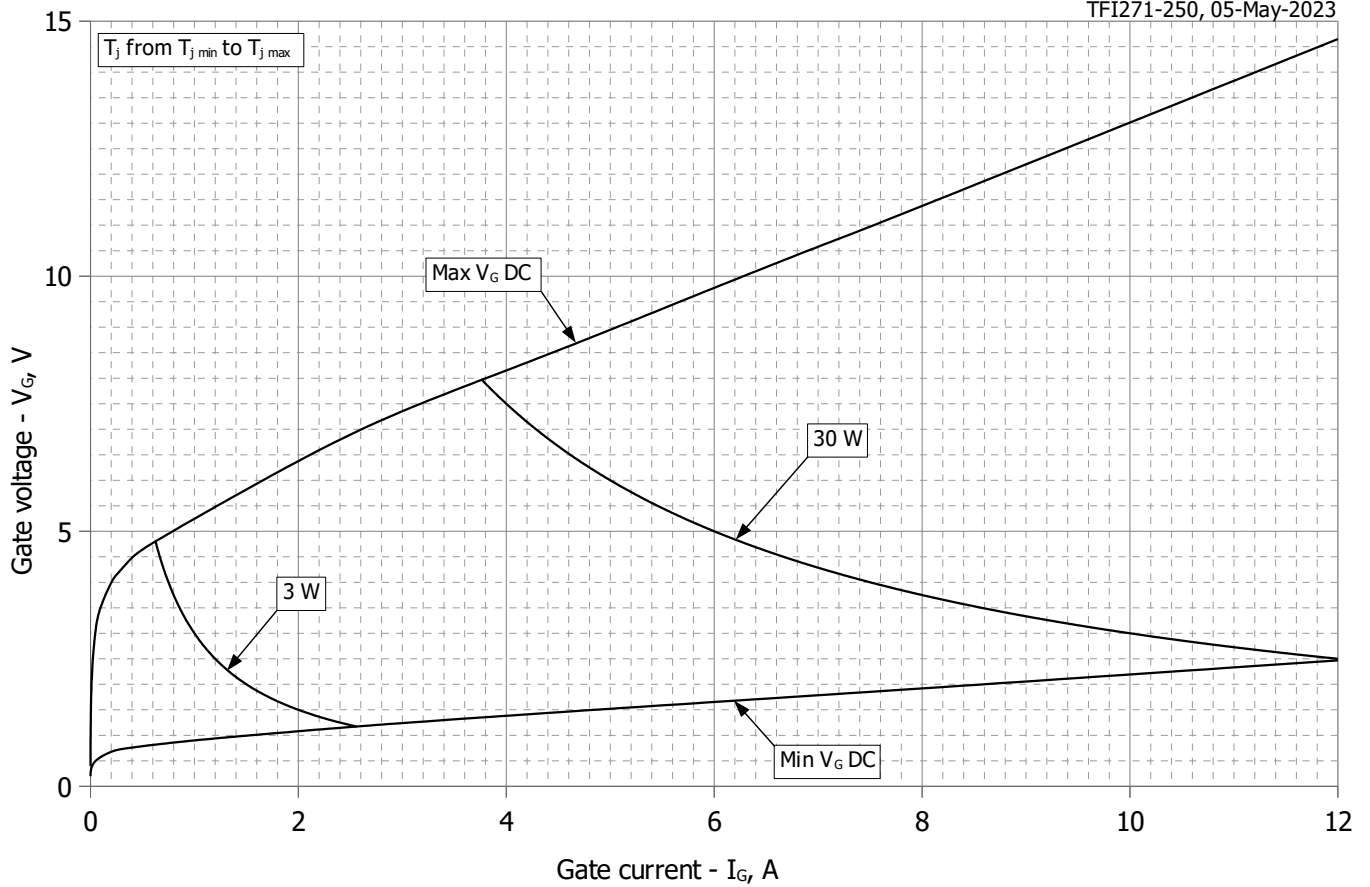


Fig 4 - Gate characteristics – Power curves

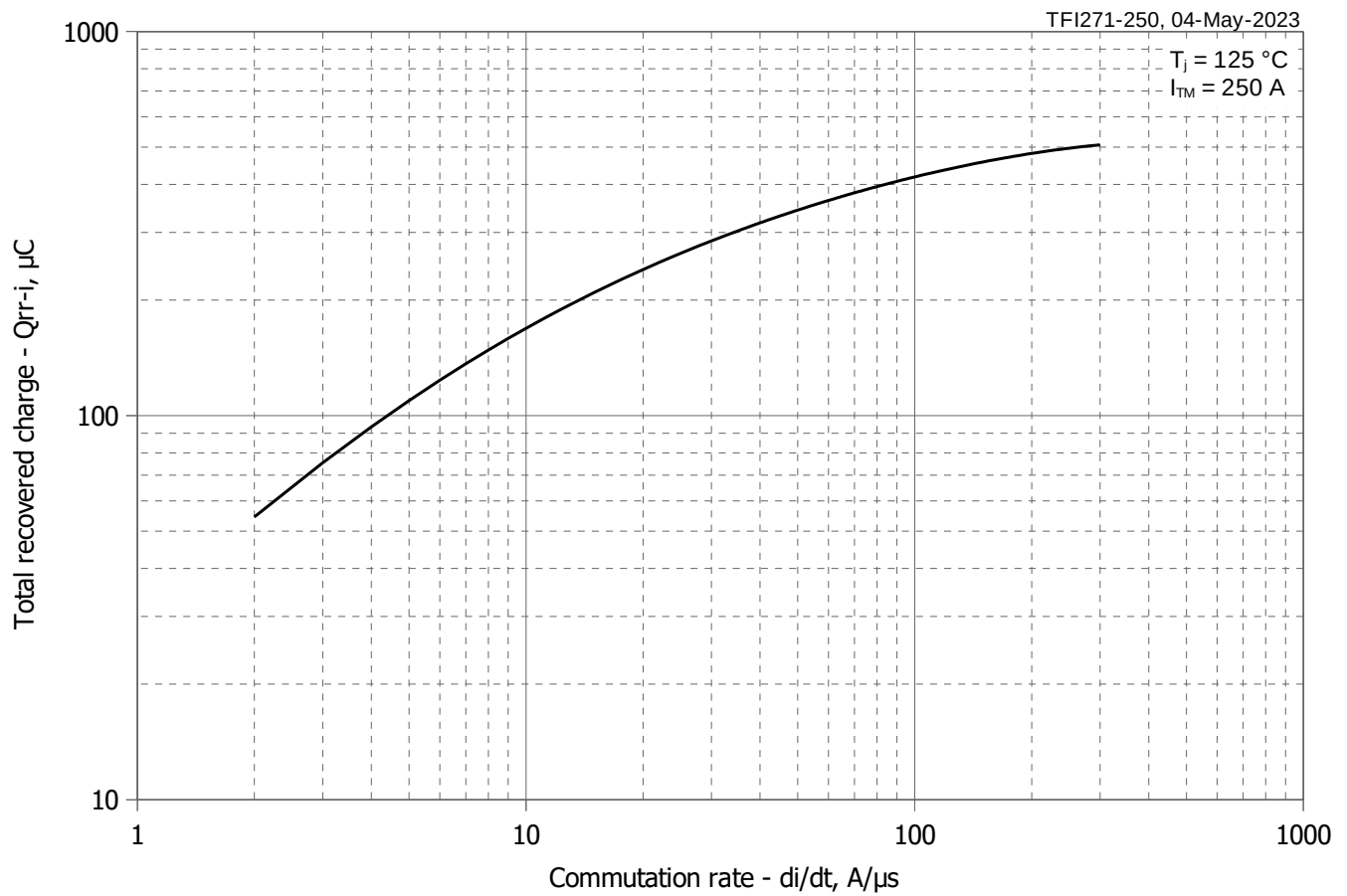


Fig 5 – Maximum recovered charge Q_{rr-i} (integral) vs. commutation rate di_R/dt

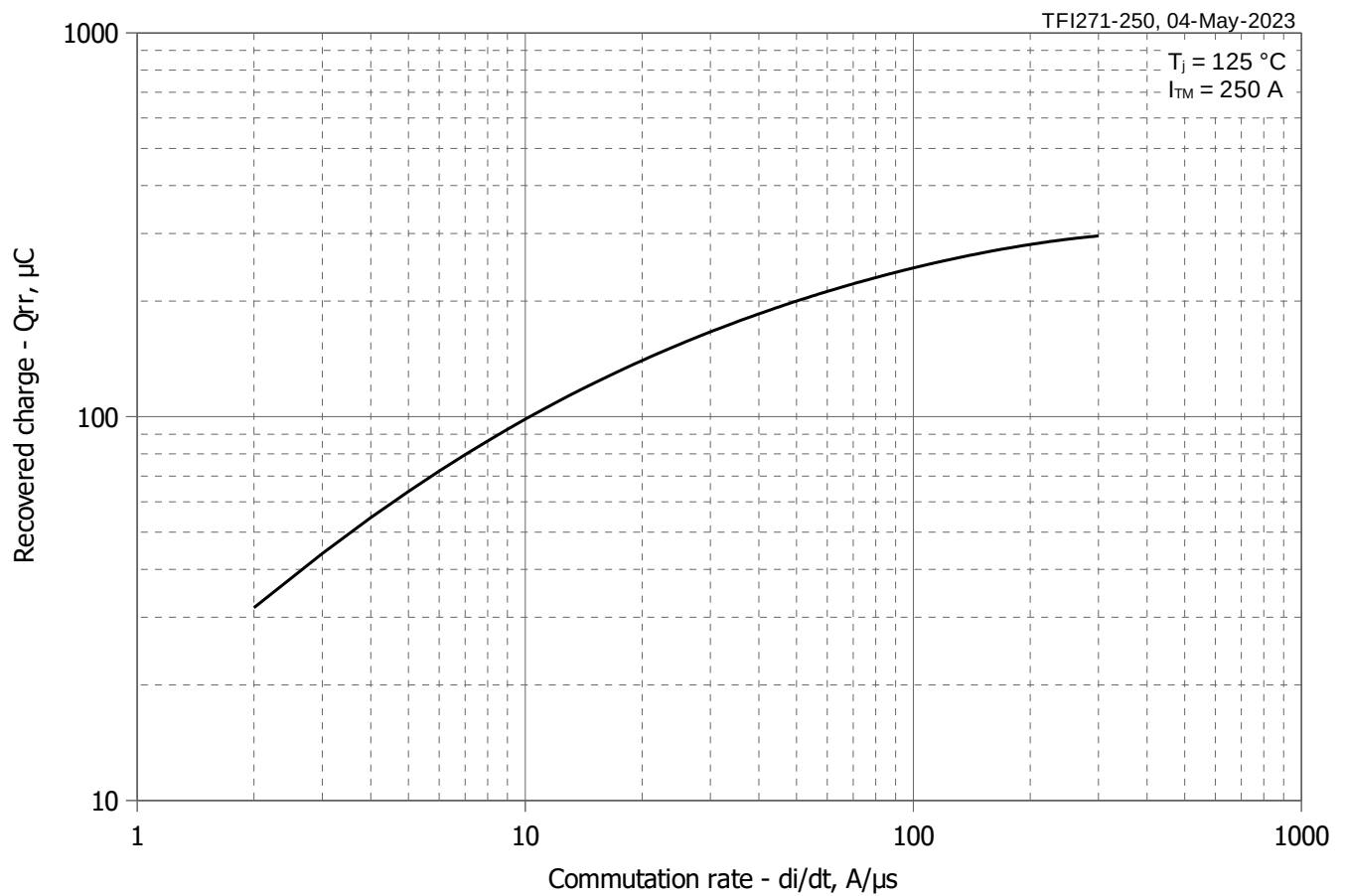


Fig 6 – Maximum recovered charge Q_{rr} vs. commutation rate di_R/dt (25% chord)

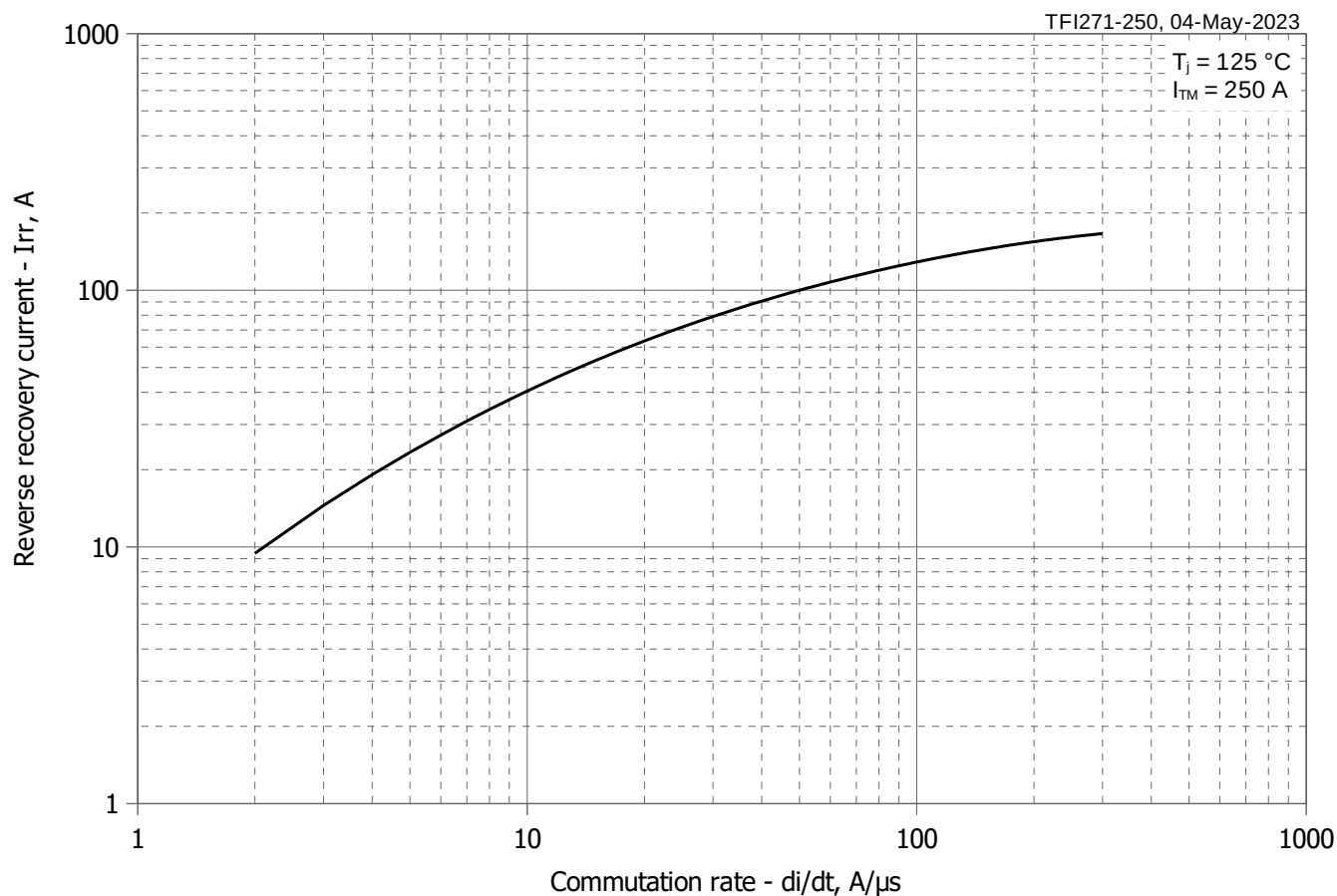


Fig 7 – Maximum reverse recovery current I_{rr} vs. commutation rate di_R/dt

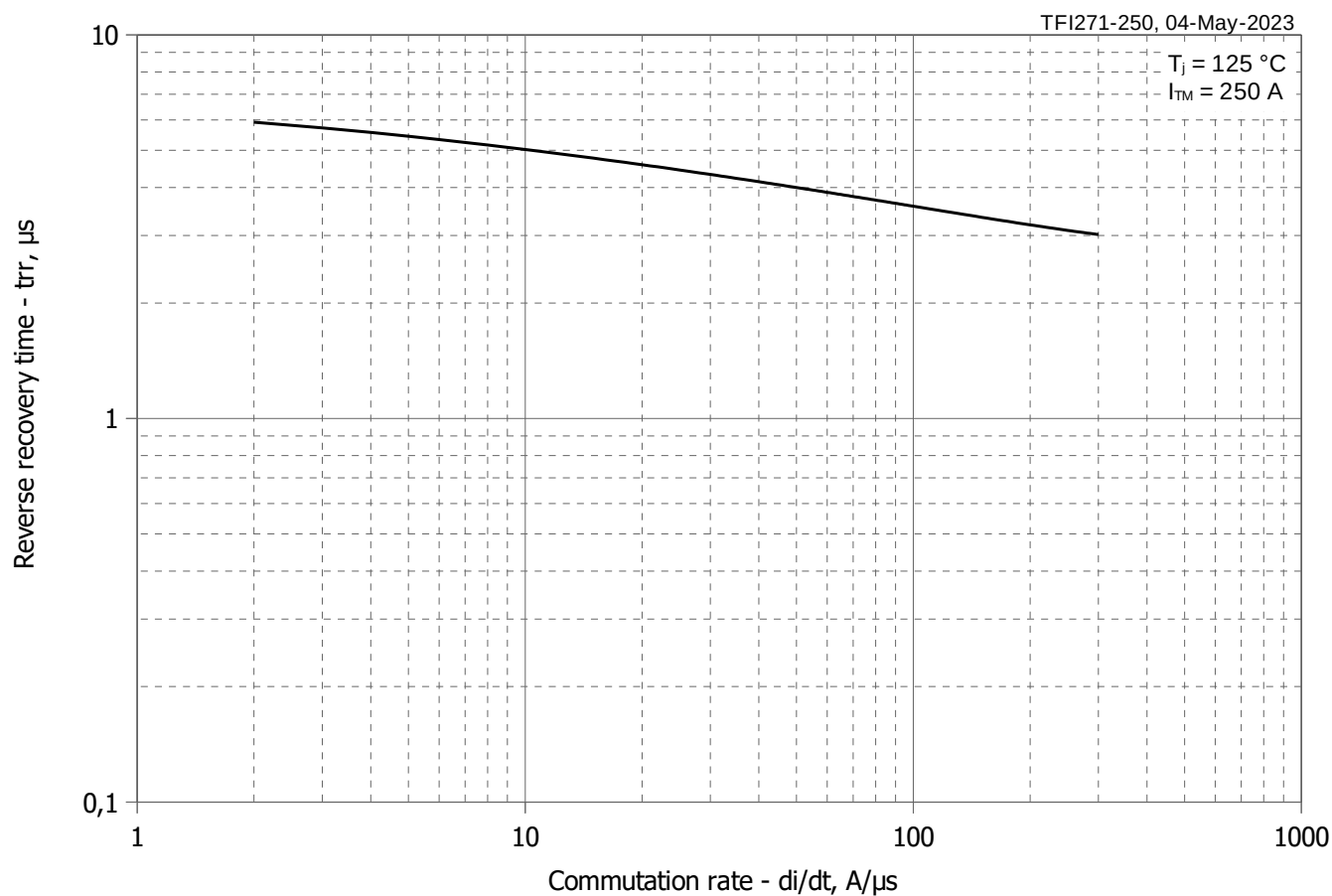


Fig 8 – Maximum recovery time t_r vs. commutation rate di_R/dt (25% chord)

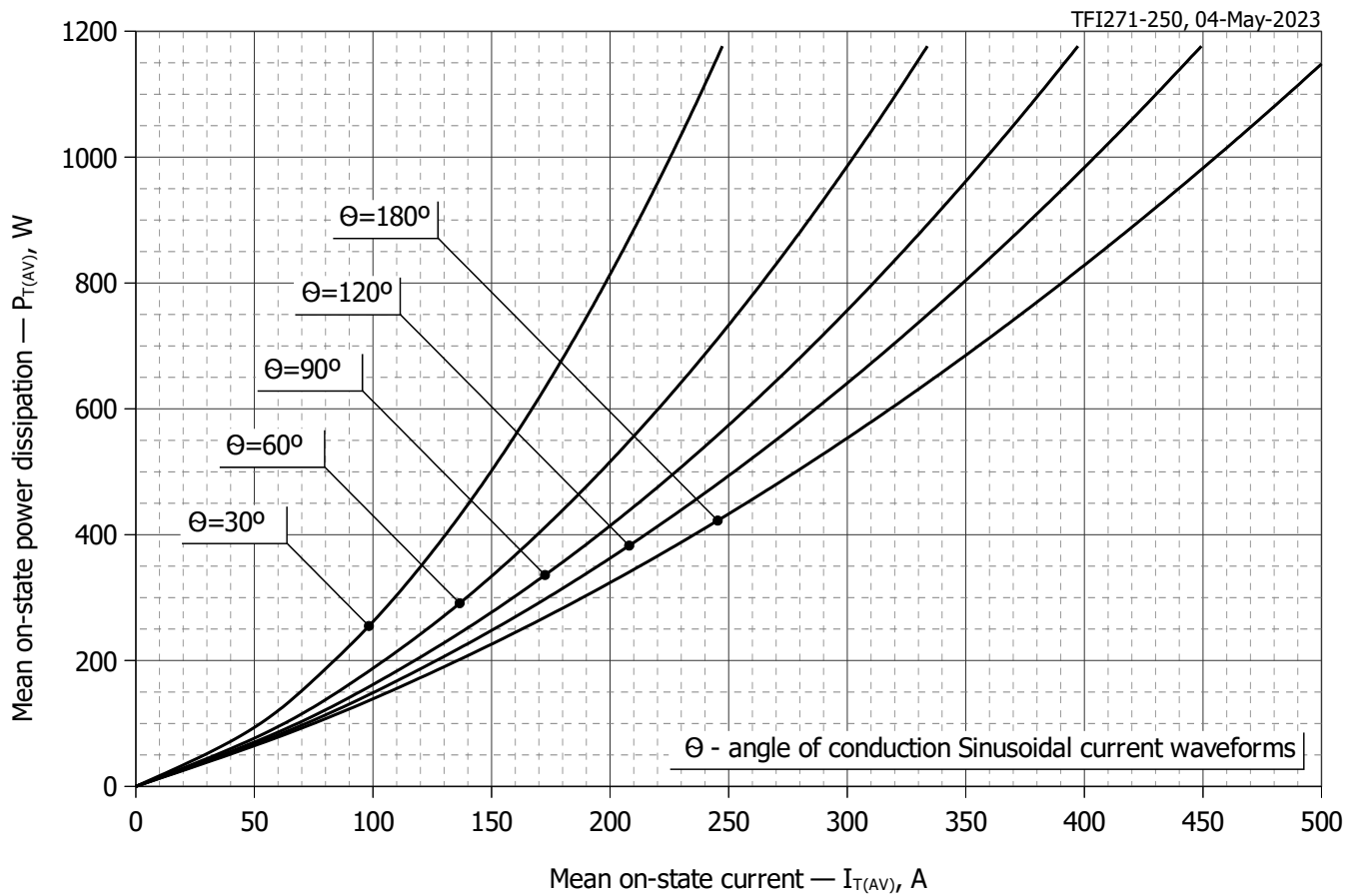


Fig. 9 - Mean on-state power dissipation P_{TAV} vs. mean on-state current I_{TAV} for sinusoidal current waveforms at different conduction angles ($f=50\text{Hz}$)

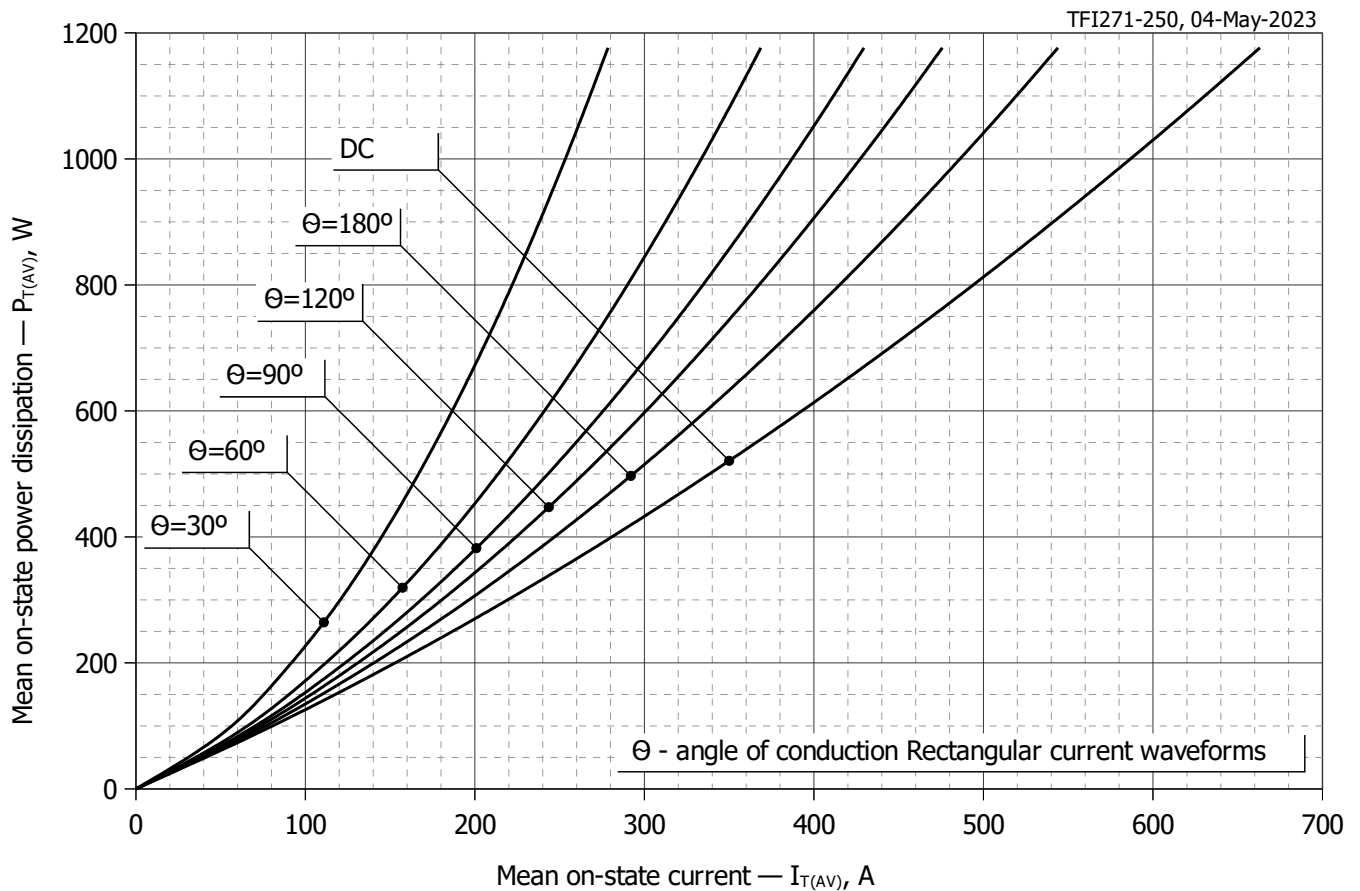


Fig. 10 – Mean on-state power dissipation P_{TAV} vs. mean on-state current I_{TAV} for rectangular current waveforms at different conduction angles and for DC ($f=50\text{Hz}$)

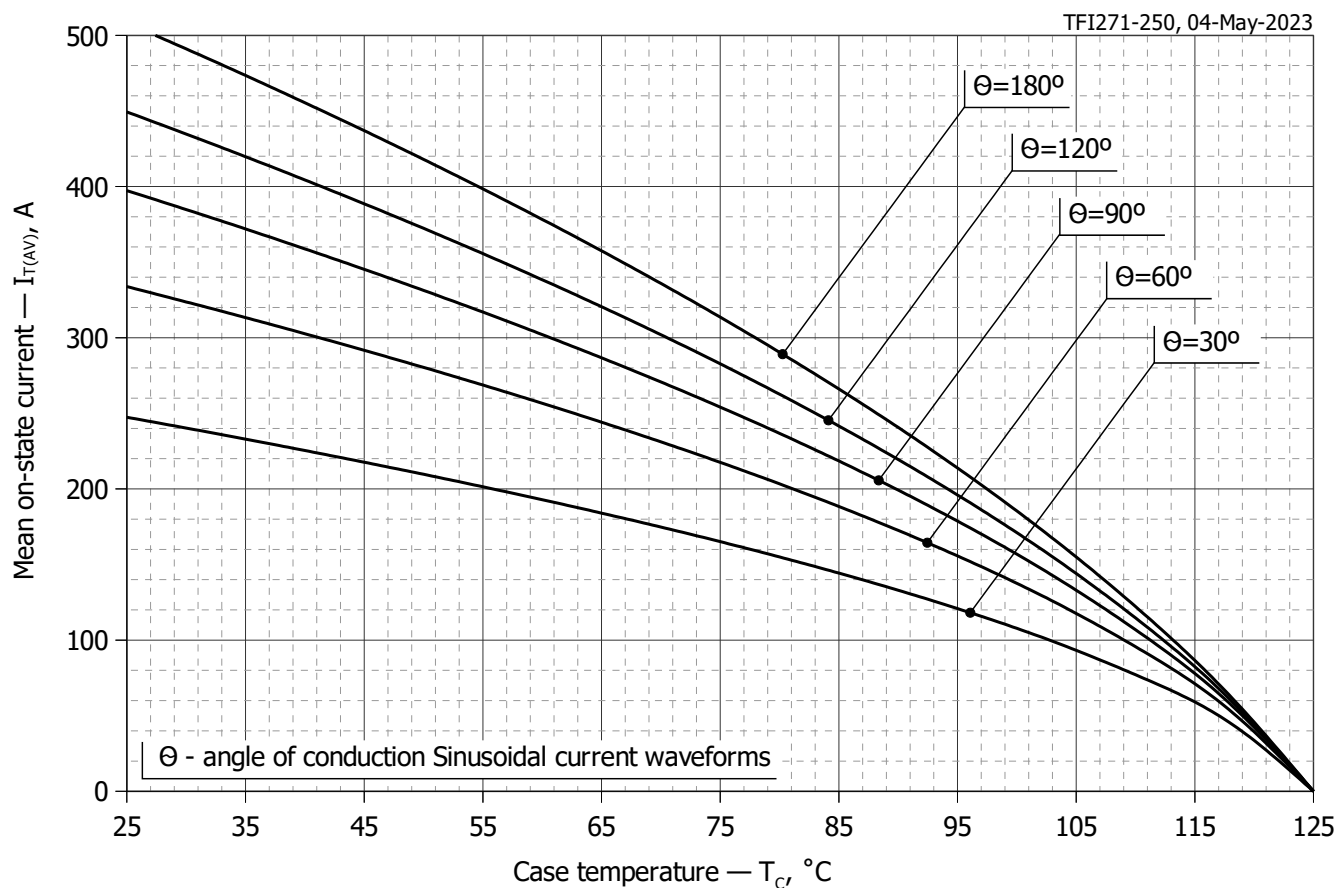


Fig. 11 – Mean on-state current I_{TAV} vs. case temperature T_c for sinusoidal current waveforms at different conduction angles ($f=50\text{Hz}$)

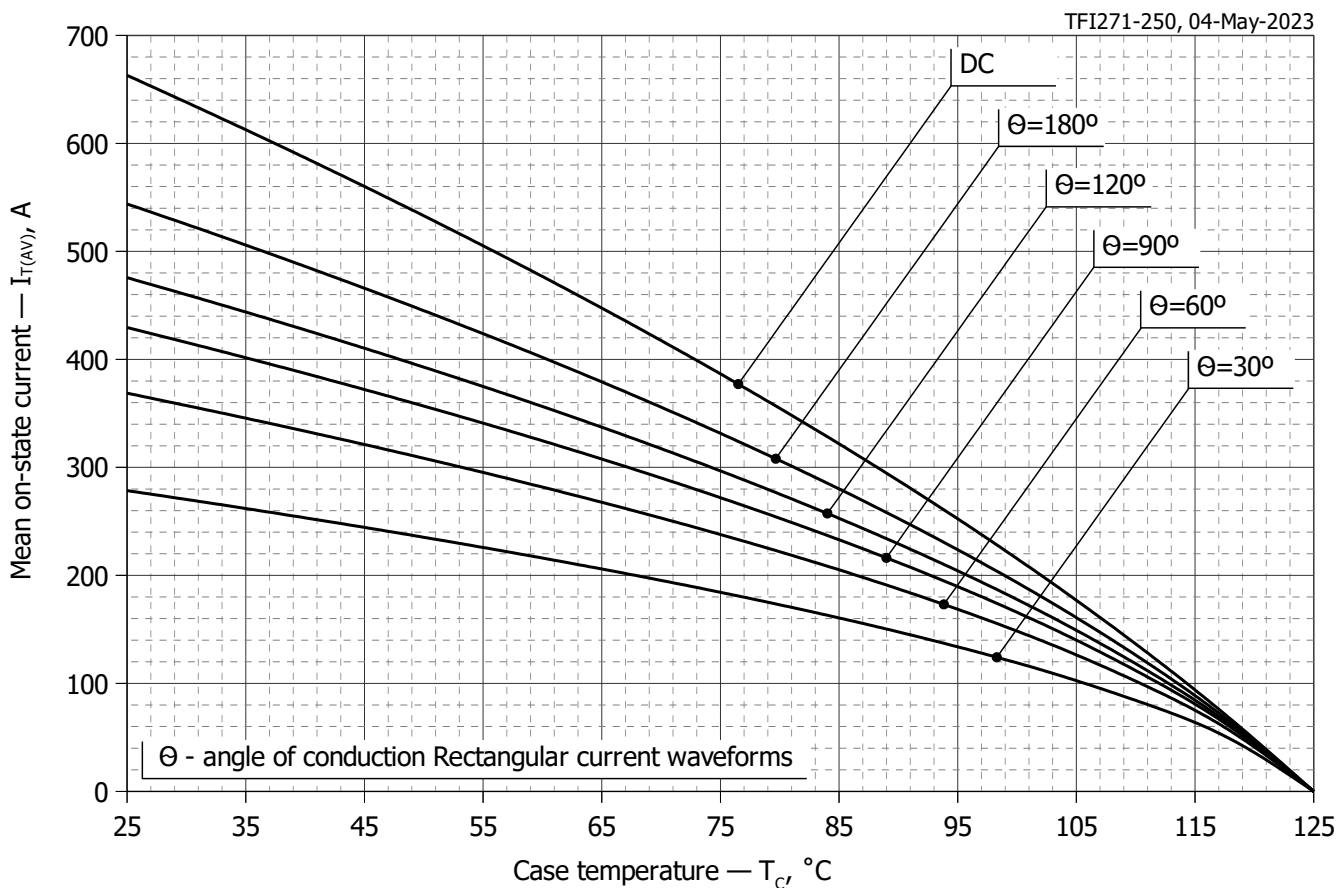


Fig. 12 - Mean on-state current I_{TAV} vs. case temperature T_c for rectangular current waveforms at different conduction angles and for DC ($f=50\text{Hz}$)

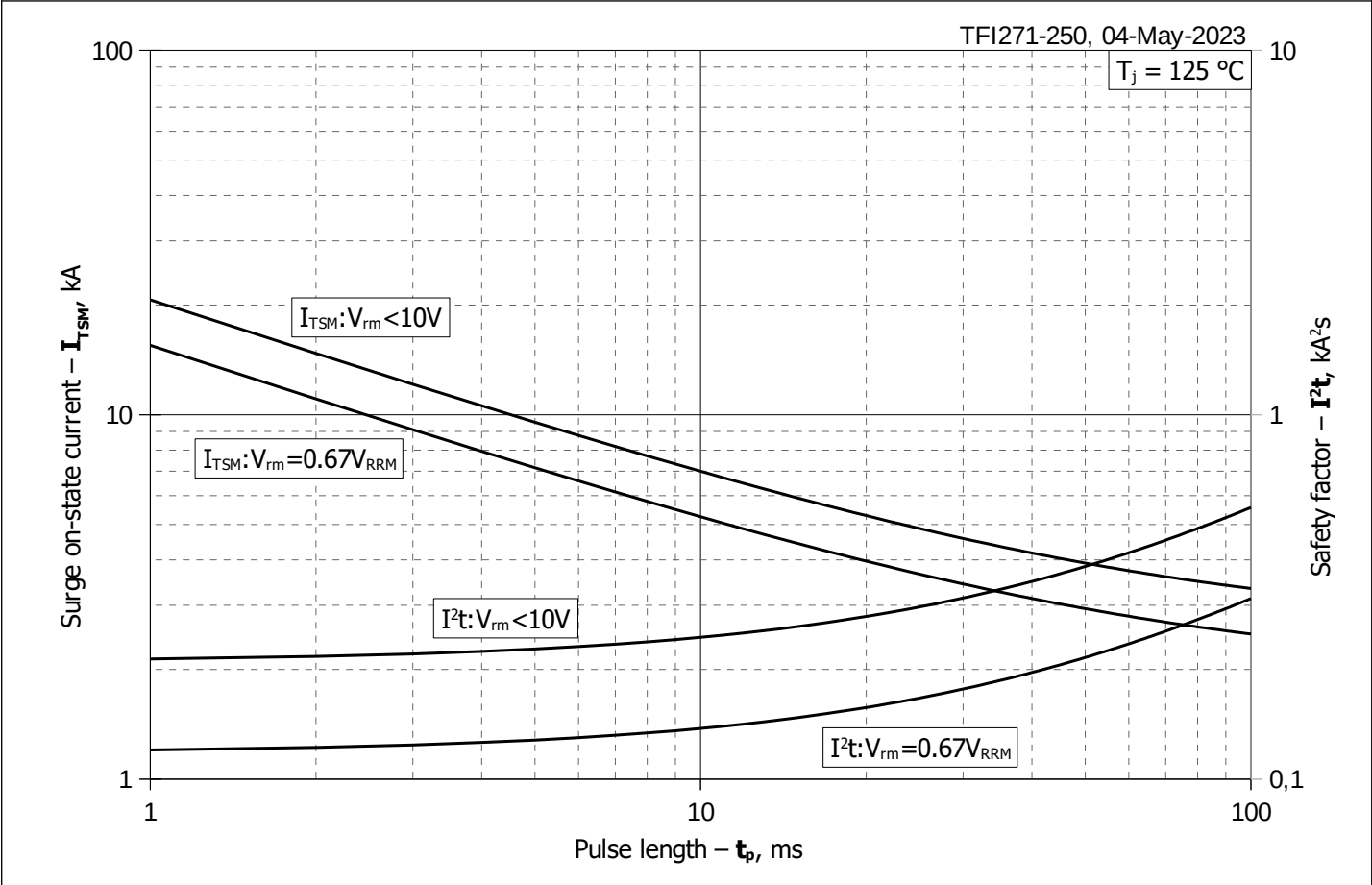


Fig. 13 – Maximum surge on-state current I_{TSM} and safety factor I^2t vs. pulse length t_p

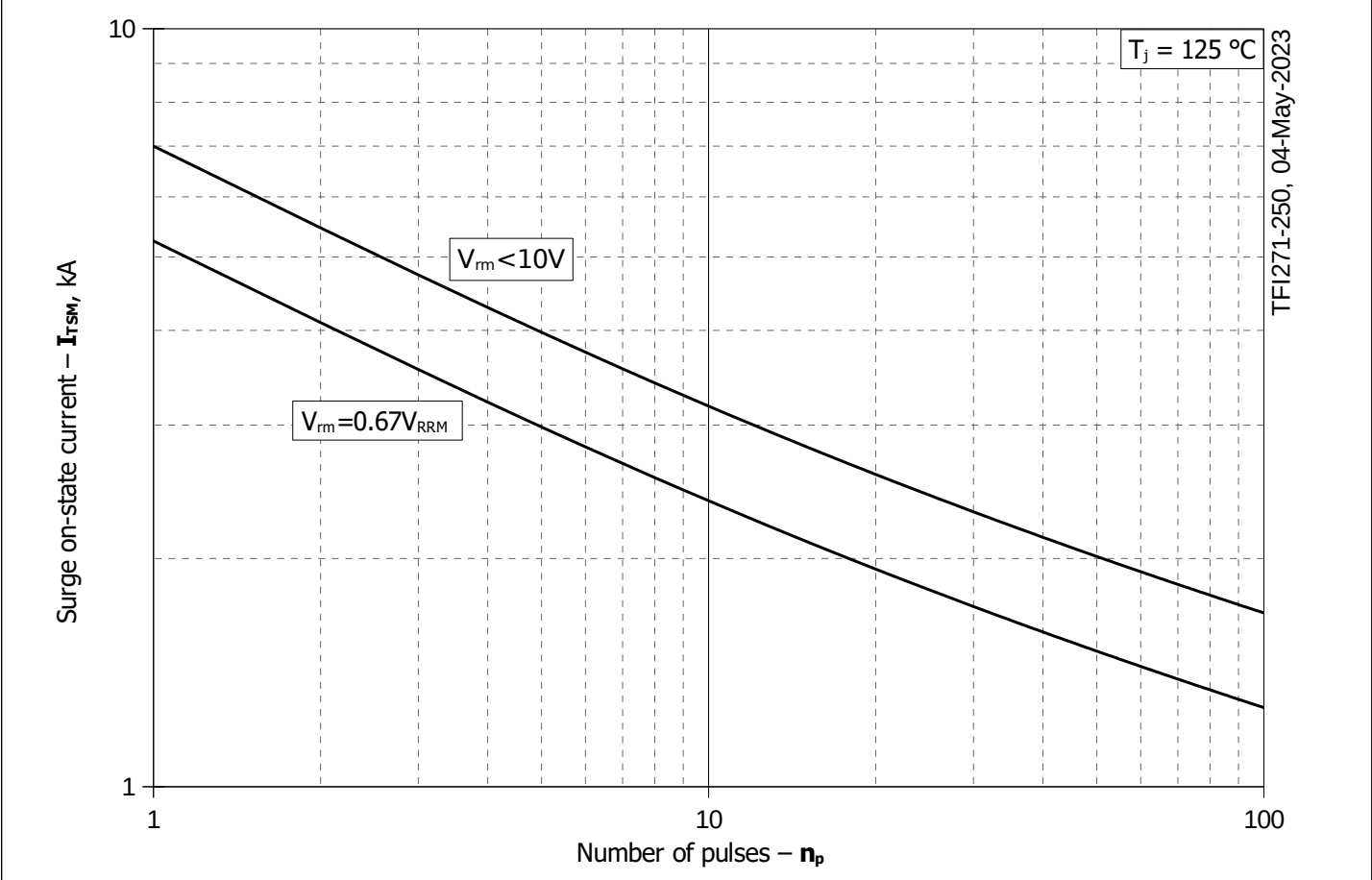


Fig. 14 - Maximum surge on-state current I_{TSM} vs. number of pulses n_p